

LM2501

Mobile Pixel Link (MPL) Camera Interface Serializer and Deserializer

General Description

The LM2501 device is a Serializer/Deserializer that adapts existing video busses to Mobile Pixel Link (MPL). MPL is intended to replace wide LVCMOS video interfaces inside portable electronics equipment benefiting their cost, size, EMI and power consumption.

By using the LM2501 SERDES chipset, the interconnect is reduced from 12 active signals to only 3 active signals providing a 75% reduction. This eases interconect and flex design, size and cost.

Contained in a 24 lead Ultra Thin CSP Package, the Serializer resides beside the video source (camera) and translates the parallel bus from LVCMOS levels to serial MPL levels for transmission over a flex cable to the Deserializer located by the respective destination Video Input Port.

An extra clock transport is provided to deliver a clock signal to the target. For example, from the main board to the flip board where the camera module is located. Transmission of the clock also benefits from MPL's low power transmission and low EMI.

The Power_Down (PD*) input controls the power state of the MPL interface. When PD* is asserted, the MD, MC and WC signals are powered down to save current and reduce power dissipation.

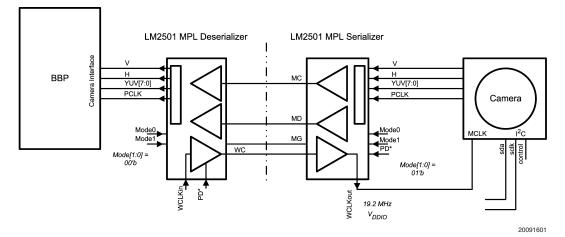
Features

- 160 Mbps Raw Throughput
- MPL-0 Meets MPL Physical Layer Specification
- Configurable as a Serializer or Deserializer
- Complete LVCMOS to MPL Translation
- Serializes 8-bit Camera Interface
 - 8-bit color data
 - plus VSYNC and HSYNC bits
- Link power down mode reduces quiescent power under
 10 μA (actual TBD)
- 1.7V-3.1V and 2.9-3.1V Supply Voltage
- Interfaces to 1.8V-3.0V Logic
- Offered in a small 24L UCSP Package
 - 3.5 mm X 4.5 mm
 - 0.6 mm Max Height

System Benefits

- Reduced Wire Interface
- Low Power
- Low EMI
- Extra Clock Transport
- Intrinsic Level Translation

Typical Application Diagram

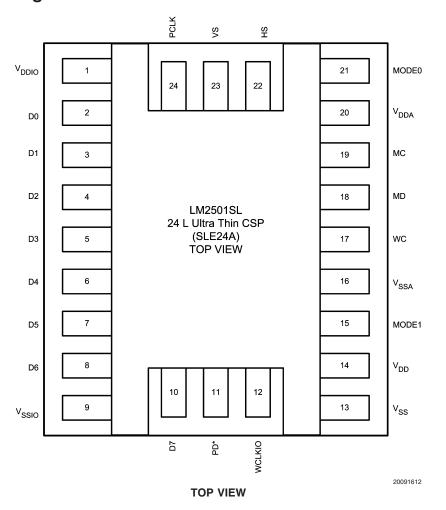


Ordering Information

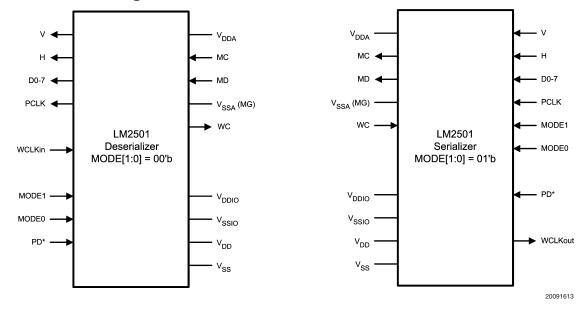
NSID	Package Type	Package ID	
LM2501SL	24-Lead Ultra Thin CSP 3.5 X 4.5 X 0.6 mm	SLE24A	

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Connection Diagram



General Block Diagrams: Serializer and Deserializer



Pin Description

Pin Name	No. of Pins	I/O, Type	Description				
MPL SERIAL BUS PINS							
MD	1	IO, MPL	MPL Data line. Serializer is a Line Driver. Deserializer is a Receiver. Configured by				
			the Mode[1:0] pins.				
MC	1	IO, MPL	MPL Clock line. Serializer is a Line Driver. Deserializer is a Receiver. Configured by				
			the Mode[1:0] pins.				
MG	1	Ground	See VSSA below.				
CONFIGURA	TION/PARA	LLEL BUS PINS					
Mode[1:0]	2	I, LVCMOS	Mode Configuration Input pins:				
			Mode[1:0], NOTE - Applies to REV F/G Samples only.				
			00 : Deserializer				
			01 : Serializer with PD* input				
			10 : Reserved				
			11 : Reserved				
PD*	1	I, LVCMOS	Power_Down. Input pin. Active Low. When PD* is Low the device is in the sleep				
			state.				
D0-D7	8	IO, LVCMOS	8-bit Bi-directional Data Bus - Serializer Input, Deserializer Output				
VS	1	IO, LVCMOS	VSYNC – Serializer Input, Deserializer Output				
HS	1	IO, LVCMOS	HSYNC - Serializer Input, Deserializer Output				
PCLK	1	IO, LVCMOS	Pixel Clock. Serializer Input, Deserializer Output				
WHISPER C	LOCK						
WCLKIO	1	IO, LVCMOS	Extra Clock Input for WhisperClock Link - Deserializer Input. Serializer Output.				
WC	1	IO, MPL	Extra WhisperClock MPL signal - Serializer is an MPL input signal, Deserializer is				
			an MPL output signal.				
POWER/GRO	OUND PINS						
V_{DDA}	1	Power	Power Supply Pin for the MPL Interface. 3.0V ± 3%				
$V_{\rm SSA}$	1	Ground	Ground Pin for the MPL Interface, also known as MG (MPL Ground)				
V_{DD}	1	Power	Power Supply Pin for the digital core and Serializer PLL. 3.0V ± 3%				
V _{SS}	1	Ground	Ground Pin for the digital core and Serializer PLL.				
$V_{\rm DDIO}$	1	Power	Power Supply Pin for the parallel interface. 1.7V to 3.1V				
V _{SSIO}	1	Ground	Ground Pin for the parallel interface.				
Notes:	1						

I = Input, O = Output, IO = Input/Output Do NOT float unused inputs.

ES Revision notes

Rev D/E	Sampled on MPL200EVK	Use prior datasheet edition
Rev F	S/D* and TM pins changed to Mode[1:0]	Use this datasheet edition
Rev G	MPL RX enhancements	

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

-0.3V to +TBDVSupply Voltage (V_{DDA}) Supply Voltage (V_{DD}) -0.3V to +TBDV Supply Voltage (V_{DDIO}) -0.3V to +TBDV -0.3V to $(V_{\rm DDIO}$ LVCMOS Input/Output Voltage +0.3V) MPL Input/Output Voltage TBD Junction Temperature +150°C -65°C to +150°C Storage Temperature Lead Temperature Soldering, 4 Seconds +260°C **ESD Ratings:** HBM, 1.5 k Ω , 100pF $\geq \pm 2 \text{ kV}$

EIAJ, 0Ω, 200 pF ≥±200V

Maximum Package Power Dissipation Capacity at 25°C

24L UCSP Package TBD W

Derate TBD Package above 25°C TBD mW/°C

Recommended Operating Conditions

	Min	Тур	Max	Units	
Supply Voltage					
$V_{\rm DDA}$ to $V_{\rm SSA}$ and					
V_{DD} to V_{SS}	2.9	3.0	3.1	V	
V_{DDIO} to V_{SSIO}	1.7		3.1	V	
PLK Clock Frequency	4		16	MHz	
WC Clock Frequency	4		28	MHz	
Ambient Temperature	0	25	70	°C	

Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified. (Note 2)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
MPL							
I _{OLL}	Logic Low Current			4.8 I _B	5.0 I _B	5.3 I _B	μΑ
I _{OMS}	Mid Scale Current				3.0 I _B		μΑ
I _{OHL}	Logic High Current			0.8 l _B	1.0 l _B	1.2 I _B	μΑ
I _B	Current Bias				150		μΑ
LVCMOS	(1.7V to 3.1V)						
V _{IH}	Input Voltage High Level			0.7 V _{DDIO}		V _{DDIO} +0.3	V
V _{IL}	Input Voltage Low Level			-0.3		0.3 V _{DDIO}	V
I _{IN}	Input Current (includes I _{OZ})			-5	0	+5	μΑ
I _{IH}	Input Current High Level			-1	0	+1	μΑ
I _{IL}	Input Current Low Level			-1	0	+1	μΑ
V _{OH}	Output Voltage High Level	$I_{OH} = -2 \text{ mA}$		0.8 V _{DDIO}			V
V_{OL}	Output Voltage Low Level	I _{OL} = 2 mA				0.2 V _{DDIO}	V
I _{os}	Output Short Circuit Current	V _{OUT} = 0V			TBD		mA
SUPPLY (URRENT						
I _{CC}	Total Supply Current—Enabled	PCLK = 16MHz WC = 28MHz	Serializer		TBD	TBD	μΑ
		$MD = 0101-1010$ $pattern$ $C_{L} = 15 pF$	Deserializer		TBD	TBD	μΑ
I _{ccz}	Supply Current—Disable	Power_Down Mode	PD* = L		1	10	μΑ
			PD* = L		1	10	μΑ

Switching Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified. (Note 2)

Symbol	Parameter	Co	onditions	Min	Тур	Max	Units
PARALLE	L BUS TIMING			'			
t _{SET}	Set Time - Data to Clock	Inputs	Figure 2	TBD			ns
HOLD	Hold Time - Clock to Data	1		TBD			ns
RISE	Rise Time	Outputs,					ns
FALL	Fall Time	$C_L = 15 \text{ pF}$					ns
PC _{LOW}	PCLK Low	1			50		%
PC _{HIGH}	PCLK High	1			50		%
DVBC	Data Valid before Clock	1	Figure 2	TBD			ns
DVAC	Data Valid after Clock	1		TBD			ns
SERIAL B	US TIMING			'	•		'
DVBC		Figure 1					
DVAC							
POWER U	P TIMING (see Figures 5, 6)			•			
1	WC Start Up Delay	Figure 5			100		WC _{CYC}
2	WC Low Initialization Low	Planned Rev G	ES test Chip will	11	12	13	
	State	1	counts on T ₁ to T ₄		12	13	WC _{CYC}
3	WC Pulse Width High	1	rs to support higher	11	12	13	WC _{CYC}
4	WC Low State	WC rates.		11	12	13	WC _{CYC}
5	WC _{IN} to WC _{OUT} Latency (SER)			6	7	8	WC _{CYC}
6	TBD	1			9		WC _{CYC}
7	SER PLL Lock Time	Figure 6			4,096		MC _{CYC}
8	MC Low Initialization Low State			11	12	13	MC _{CYC}
9	MC Pulse Width High	1		11	12	13	MC _{CYC}
10	MC Low State	1		11	12	13	MC _{CYC}
11	SER Latency	1			TBD		MC _{CYC}
12	DES Latency	1			TBD		MC _{CYC}
OWER O	FF TIMING	,		1	,	•	
PAZ	Disable Time to Power Off						μs
PZA	Enable Time from Power Off						μs

Input Timing Requirements

Over recommended operating supply and temperature ranges unless otherwise specified. (Note 2)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
REFEREN	CE CLOCK (WCLK _{IN})		•	•		
f _{WC}	Clock Frequency		4		28	MHz
WC _{DC}	Clock Duty Cycle		45	50	55	%
t _T	Clock Transition Times (Rise or Fall, 10%–90%)		1		6	ns
PIXEL CLO	OCK (PCLK)					
f _{PCLK}	Clock Frequency		4		16	MHz
t _{CP}	Clock Period		62.5		250	ns
CLK _{DC}	Clock Duty Cycle		45	50	55	%
t _T	Clock transition Time		1		6	ns

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

Note 3: Current into a device pin is defined as positive. Current out of device pins is defined as negative. Voltages are referenced to Ground unless otherwise specified.

Timing Diagrams

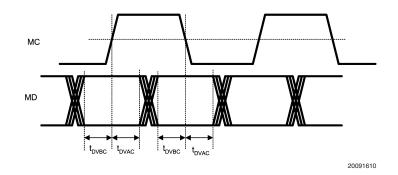


FIGURE 1. Serial Data Valid

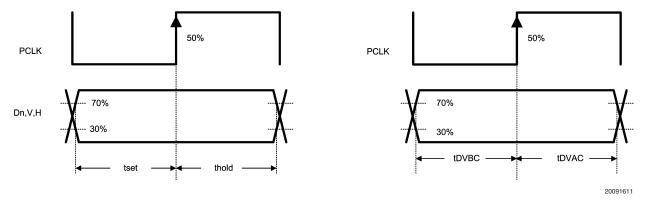


FIGURE 2. Parallel Set, Hold and Data Valid

Note 2: Typical values are given for $V_{DD} = V_{DDA} = 3.0V$ and $V_{DDIO} = 2.7V$ and $T_A = 25^{\circ}C$.

Application Information

Typical application connections for the LM2501 are shown below.

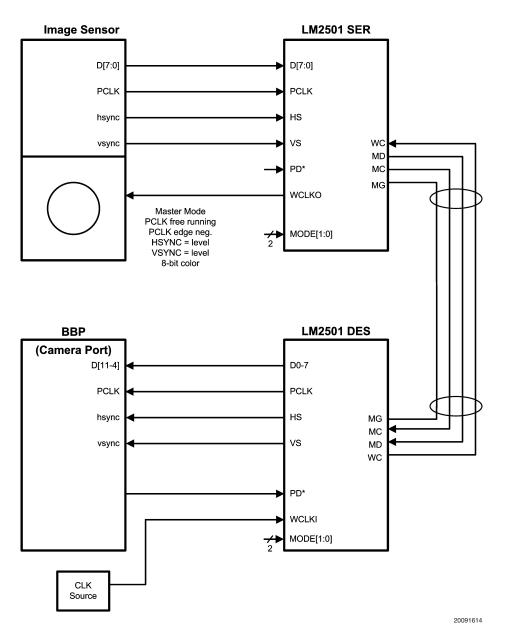


FIGURE 3. Camera Application

The application shown in Figure 3 illustrates a connection between an Image sensor and a host utilizing an MPL-0 link. .

Functional Description

SERIAL BUS OPERATION

Bus Overview

The MPL bus is a simple 2-signal line interface that is intended to replace wide low voltage CMOS video busses inside handheld portable devices. The MPL physical layer is purpose-built for an extremely low power and low EMI data transmission while requiring the fewest number of signal lines. No external line components are required, as termina-

tion is provided internal to the MPL receiver. The MPL interface is designed to be used with common 50 Ω lines using standard materials and connectors. Lines may be microstrip or stripline construction. Total length of the interconnect is expected to be less than 0.3 meters. This device is meets the requirements of the MPL-0 Standard (PHY Layer only).

SERIAL BUS TIMING

Data valid is relative to both edges as shown in *Figure 4*. Data valid is specified as: Data Valid before Clock, Data Valid after Clock, (Note relative to both edges).

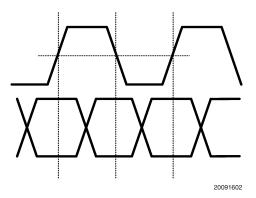


FIGURE 4. Master-to-Slave Timing (MC, MDm)

SERIAL BUS PHASES

There are three bus phases on the MPL serial bus. These are determined by the state of the MC and MD lines. Two of the bus phases have options. The MPL bus phases are shown in *Table 1*.

TABLE 1. MPL Bus Phases

Name		WC State	MC State	MD State	Phase Description	Pre-Phase	Post-Phase
OFF (O)		0	0	0	Bus is Powered-Off	na	I (WC)
Initialization (I)	WC	Α	0	0	WC Start Up	0	I (MC)
	MC/MD	А	Α	0	MPL Start Up	I (WC)	A
Active (A)		А	А	Х	Data Out (Write)	I (MC)	A or O

Notes on Line State: 0 = no current (off), L = Logic Low, H = Logic High, X = Low or High, A — Active Clock

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Functional Description (Continued)

SERIAL BUS POWER-UP

In the sleep state, WC, MC and MD are turned off with zero current flowing. Both devices need to be enabled by assert-

ing their PD* inputs. The DES will then initialize the SER via the WC signal as shown in Figure 5. The DES waits 7 WC cycles before its $WCLK_{out}$ is active. Note, there is no phase or frequency relationship between WC and MC.

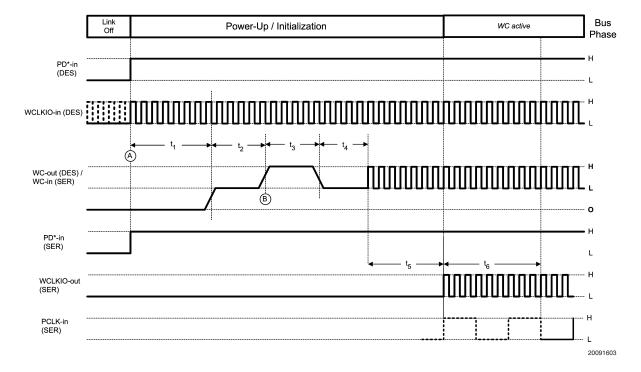


FIGURE 5. Bus Power Up Timing—WC

Functional Description (Continued)

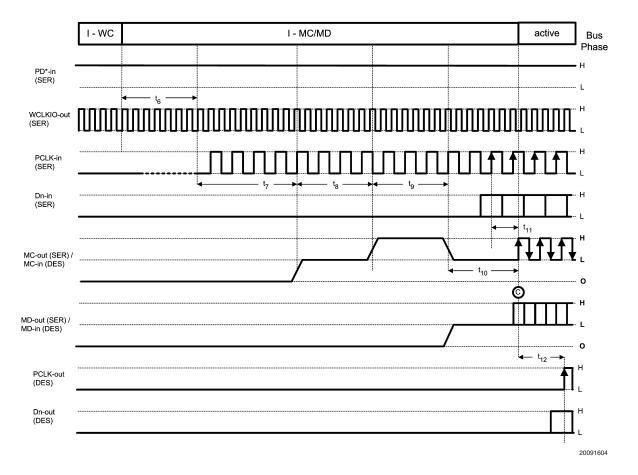


FIGURE 6. Bus Power Up Timing—MC/MD

In Figure 6, the Serializer timing is shown. For the part to establish lock, WCLKIO(out) must be active, and a valid PCLK applied. After lock is obtained, the MC and MD lines are initialized and then active transmission occurs. Table Switching Characteristics lists the timing parameters of Figures 5, 6.

SERIAL BUS POWER-OFF

In the power-off state, WC, MD and MC are turned off with zero current flowing. This is considered the Sleep state (Power-off) and the transition off may occur after the last data bit time or at any time afterwards from an Idle phase as shown in *Figure 7*.

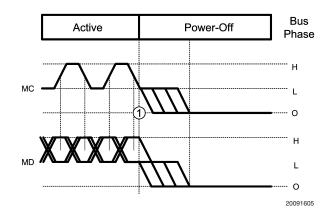


FIGURE 7. Bus Power Down Timing

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Functional Description (Continued)

CAMERA INTERFACE

The Camera Interface provides serialization of color and control bits. The interface provides data transport in a single direction. Byte alignment is provided by the intrinsic first

rising edge of the MC line. PCLK is required and must be **free-running**. Data may be raw Bayer or BT656 color information. Data is strobed on the **rising-edge** on the input to the Serializer. Data is sent LSB first (D0).

MPL provides the data transport path, control of the Camera device is provided by an I^2C control bus.

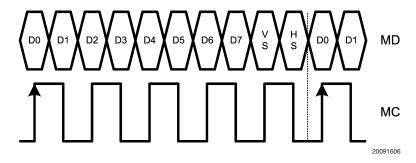


FIGURE 8. Camera Mode Serial Interface

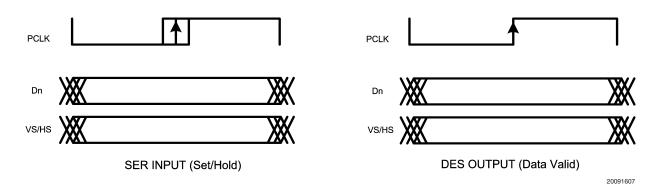


FIGURE 9. Parallel Bus Timing

Features and Operation

POWER DOWN/OFF

The device may be powered by its PD* pin. A Low on this pin will power down the entire device.

TABLE 2. Power Down Output States

Mode	Pin	Туре	Output State in Power Down
SER	WCLKIO	LVCMOS	LOW
SER	MC	MPL	OFF
SER	MD	MPL	OFF
DES	D[0:7]	LVCMOS	LOW
DES	V, H	LVCMOS	LOW
DES	PCLK	LVCMOS	LOW
DES	WC	MPL	OFF

UN-USED/OPEN INPUTS

Un-used control/inputs pins must be driven to their appropriate logic states to set up the desired operating modes.

UN-USED OUTPUTS

Unused outputs should be left open to minimize power dissipation.

POWERING UP

The LM2501 should be powered up with all power supplies at the same time, alternately VDDIO may lag VDD and VDDA. Do not power up with VDDIO before VDD and VDDA.

PHASE-LOCKED LOOP

When the device is configured as a Serializer, a PLL is provided to generate the serial link clock. The Phase-locked loop system generates the serial data clock at five times the input clock. The PLL operates with an input clock between 4 MHz and 16 MHz. The Deserializer does not utilize the PLL and its PLL is powered down.

RESET

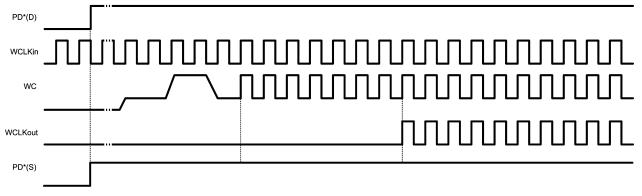
PD* should be held Low until the power supply has powered up and is stable. The PD* should then be de-asserted to generate a RESET and start up. Stopping the WCLKIO or the PCLK will not RESET the part. A power cycle or PD* cycle is requested to generate a RESET event.

SERIALIZER/DESERIALIZER SELECTION

The Mode[1:0] pins are used to configure the device as either a Serializer or Deserializer and other configuration options.

WHISPERCLOCK

An additional clock signal is sent from the Deserializer to the Serializer. This can be used to pass a clock reference (4 MHz to 28 MHz) up to the Camera device from the host. This link is independent of the Serial data path (opposite direction). See also *Figure 5*. The SER can only start up, if the WCLKIO(ser-out) has been active.



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FIGURE 10. Sleep to Active

Features and Operation (Continued)

When the Deserializer's PD* signal is de-asserted, the WC output will power up and initialize the serializer and start transmitting the clock reference. Once the Serializer received the clock, it waits seven cycles, and then outputs the

clock signal. Seven cycles later, the Serializer's PLL will begin to lock if PCLK is present.

When the Deserializer's PD* signal is asserted, the WC signal is turned off.

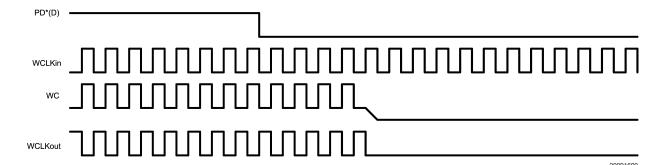


FIGURE 11. Active to Sleep

MISC. Definitions:

Bus States:

Logic Low — 5Idata flowing from the Receiver to the

Driver

Logic High — Idata flowing from the Receiver to the Driver

Power Off — No Current flowing in the interconnect

Signals & Nomenclature:

MD = MPL Data Signal, subscript denotes source, m =

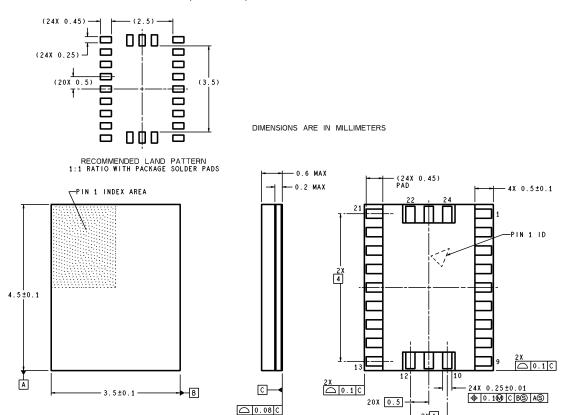
master, s = slave

MC = MPL Clock Signal

WC = MPL WhisperClock Signal

* = Active Low Signal

Physical Dimensions inches (millimeters) unless otherwise noted



Order Number LM2501SL NS Package Number SLE24A

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